Supplementary Materials:

Nanostructure Enhanced Ionic Transport in Fullerene Reinforced Solid Polymer Electrolytes

Che-Nan Sun, Thomas A. Zawodzinski Jr., Wyatt E. Tenhaeff, Fei Ren, Jong Kahk Keum, Sheng Bi, Dawen Li, Suk-Kyun Ahn, Kunlun Hong, Adam J. Rondinone, Jan-Michael Y. Carrillo, Changwoo Do, Bobby G. Sumpter, Jihua Chen*

Dr. C.N. Sun, Prof. T. A. Zawodzinski,

Materials Science & Technology Division, Oak Ridge National Laboratory P.O. Box 2008. Oak Ridge, TN, USA Prof. T. A. Zawodzinski Department of Chemical and Biomolecular Engineering, University of Tennessee, Knoxville, TN 37996, USA Prof. W. E. Tenhaeff Department of Chemical Engineering, University of Rochester, Rochester, NY 14627 USA Prof. F. Ren Department of Mechanical Engineering, Temple University, Philadelphia, PA 19122 USA Dr. J.K. Keum, Dr. C. Do Neutron Scattering Science Division, Oak Ridge National Laboratory, Oak Ridge, TN 37831, USA S. Bi, Prof. D. Li Department of Electrical and Computer Engineering, Center for Materials Information Technology, University of Alabama, Tuscaloosa, AL 35487, USA Dr. J. Chen, Dr. B. G. Sumpter, Dr. S. K. Ahn, Dr. K. Hong, Dr. A. J. Rondinone, Dr. J.-M.Y. Carrillo Center for Nanophase Materials Sciences, Oak Ridge National Laboratory, Oak Ridge, TN 37831, USA Dr. B. G. Sumpter, Dr. J.-M.Y. Carrillo Computer Science and Mathematics Division, Oak Ridge National Laboratory P.O. Box 2008. Oak Ridge, TN, USA

Corresponding author: Dr. Jihua Chen, chenj1@ornl.gov

	Arrhenius		VTF
PCBM wt%	E _a (J)	В (К)	Т ₀ (К)
0	4.01×10 ⁻²⁰ (±7.9×10 ⁻²²)	895(±377)	249(±14)
10	7.08×10 ⁻²⁰ (±1.29×10 ⁻²⁰)	470(±791)	269(±35)
20	5.13×10 ⁻²⁰ (±1.51×10 ⁻²¹)	375(±335)	272(±18)
40	5.85×10 ⁻²⁰ (±5.3×10 ⁻²¹)	378(±658)	273(±33)

 Table S1. Arrhenius and VTF fitting parameters from Figure 1a.



Figure S1. Fitting results on double layer permittivity (ε_{DL}) by equivalent circuit modeling as a function of PCBM loading and temperature. The circuit model and other fitting results are shown in Figure 2 and Figure S2.



Figure S2. Fitting results in equivalent circuit modeling as a function of PCBM loading and temperature. The circuit model and other fitting results are shown in Figure 2 and Figure S1.



Figure S3. Thickness maps of PEO/LiTFSi films as a function of the PCBM percentage (wt%). The scale bars are 20 nm. Three typical line scans of thickness map are given for 0%, 20% and 40% PCBM blends, which do not show significant differences in thickness variation. The t/ λ values are extracted from the thickness map, which are generated by intensity ratios of filtered and unfiltered TEM images from an identical area. Film thickness t is in nanometer, while λ (an unknown constant) stands for the mean free path of the incident electrons upon their interactions with sample film.